

# IRFPS40N50LPbF

## SMPS MOSFET

HEXFET® Power MOSFET

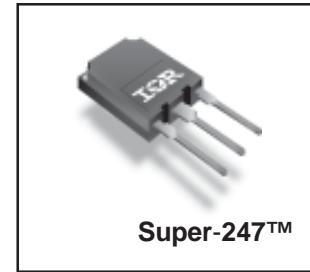
<b>V<sub>DSS</sub></b>	<b>R<sub>DS(on)</sub> typ.</b>	<b>T<sub>rr</sub> typ.</b>	<b>I<sub>D</sub></b>
500V	0.087Ω	170ns	46A

### Applications

- Zero Voltage Switching SMPS
- Telecom and Server Power Supplies
- Uninterruptible Power Supplies
- Motor Control applications
- Lead-Free

### Features and Benefits

- SuperFast body diode eliminates the need for external diodes in ZVS applications.
- Lower Gate charge results in simpler drive requirements.
- Enhanced dv/dt capabilities offer improved ruggedness.
- Higher Gate voltage threshold offers improved noise immunity.

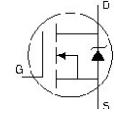


Super-247™

### Absolute Maximum Ratings

	Parameter	Max.	Units
I <sub>D</sub> @ T <sub>C</sub> = 25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V	46	A
I <sub>D</sub> @ T <sub>C</sub> = 100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V	29	
I <sub>DM</sub>	Pulsed Drain Current ①	180	
P <sub>D</sub> @ T <sub>C</sub> = 25°C	Power Dissipation	540	W
	Linear Derating Factor	4.3	W/°C
V <sub>GS</sub>	Gate-to-Source Voltage	±30	V
dv/dt	Peak Diode Recovery dv/dt ②	34	V/ns
T <sub>J</sub>	Operating Junction and	-55 to + 150	
T <sub>STG</sub>	Storage Temperature Range		
	Soldering Temperature, for 10 seconds	300 (1.6mm from case )	

### Diode Characteristics

Symbol	Parameter	Min.	Typ.	Max.	Units	Conditions
I <sub>S</sub>	Continuous Source Current (Body Diode)	—	—	46	A	MOSFET symbol showing the integral reverse p-n junction diode.
I <sub>SM</sub>	Pulsed Source Current (Body Diode) ①	—	—	180		
V <sub>SD</sub>	Diode Forward Voltage	—	—	1.5	V	T <sub>J</sub> = 25°C, I <sub>S</sub> = 46A, V <sub>GS</sub> = 0V ④
t <sub>rr</sub>	Reverse Recovery Time	—	170	250	ns	T <sub>J</sub> = 25°C, I <sub>F</sub> = 46A
		—	220	330		T <sub>J</sub> = 125°C, di/dt = 100A/μs ④
Q <sub>rr</sub>	Reverse Recovery Charge	—	705	1060	nC	T <sub>J</sub> = 25°C, I <sub>S</sub> = 46A, V <sub>GS</sub> = 0V ④
		—	1.3	2.0		T <sub>J</sub> = 125°C, di/dt = 100A/μs ④
I <sub>RRM</sub>	Reverse Recovery Current	—	9.0	—	A	T <sub>J</sub> = 25°C
t <sub>on</sub>	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

# IRFPS40N50LPbF

International  
Rectifier

## Static @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{DSS}}$	Drain-to-Source Breakdown Voltage	500	—	—	V	$V_{GS} = 0V, I_D = 250\mu\text{A}$
$\Delta V_{(\text{BR})\text{DSS}/\Delta T_J}$	Breakdown Voltage Temp. Coefficient	—	0.60	—	V/ $^\circ\text{C}$	Reference to $25^\circ\text{C}, I_D = 1\text{mA}$
$R_{DS(\text{on})}$	Static Drain-to-Source On-Resistance	—	0.087	0.100	$\Omega$	$V_{GS} = 10V, I_D = 28\text{A}$ ④
$V_{GS(\text{th})}$	Gate Threshold Voltage	3.0	—	5.0	V	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$
$I_{\text{DSS}}$	Drain-to-Source Leakage Current	—	—	50	$\mu\text{A}$	$V_{DS} = 500V, V_{GS} = 0V$ $V_{DS} = 400V, V_{GS} = 0V, T_J = 125^\circ\text{C}$
	—	—	2.0	—	mA	
$I_{GSS}$	Gate-to-Source Forward Leakage	—	—	100	nA	$V_{GS} = 30V$
	—	—	-100	—	—	$V_{GS} = -30V$
$R_G$	Internal Gate Resistance	—	0.90	—	$\Omega$	$f = 1\text{MHz}$ , open drain

## Dynamic @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Units	Conditions
$g_{fs}$	Forward Transconductance	21	—	—	S	$V_{DS} = 50V, I_D = 46\text{A}$
$Q_g$	Total Gate Charge	—	—	380	nC	$I_D = 46\text{A}$
$Q_{gs}$	Gate-to-Source Charge	—	—	80	nC	$V_{DS} = 400V$
$Q_{gd}$	Gate-to-Drain ("Miller") Charge	—	—	190	nC	$V_{GS} = 10V$ , See Fig. 7 & 15 ④
$t_{d(on)}$	Turn-On Delay Time	—	27	—	ns	$V_{DD} = 250V$
$t_r$	Rise Time	—	170	—	ns	$I_D = 46\text{A}$
$t_{d(off)}$	Turn-Off Delay Time	—	50	—	ns	$R_G = 0.85\Omega$
$t_f$	Fall Time	—	69	—	ns	$V_{GS} = 10V$ , See Fig. 14a & 14b ④
$C_{iss}$	Input Capacitance	—	8110	—	pF	$V_{GS} = 0V$
$C_{oss}$	Output Capacitance	—	960	—	pF	$V_{DS} = 25V$
$C_{rss}$	Reverse Transfer Capacitance	—	130	—	pF	$f = 1.0\text{MHz}$ , See Fig. 5
$C_{oss}$	Output Capacitance	—	11200	—	pF	$V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0\text{MHz}$
$C_{oss}$	Output Capacitance	—	240	—	pF	$V_{GS} = 0V, V_{DS} = 400V, f = 1.0\text{MHz}$
$C_{oss \text{ eff.}}$	Effective Output Capacitance	—	440	—	pF	$V_{GS} = 0V, V_{DS} = 0V \text{ to } 400V$ ⑤
$C_{oss \text{ eff. (ER)}}$	Effective Output Capacitance (Energy Related)	—	310	—	pF	

## Avalanche Characteristics

Symbol	Parameter	Typ.	Max.	Units
$E_{AS}$	Single Pulse Avalanche Energy ⑥	—	920	mJ
$I_{AR}$	Avalanche Current ⑦	—	46	A
$E_{AR}$	Repetitive Avalanche Energy ⑧	—	54	mJ

## Thermal Resistance

Symbol	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case ⑨	—	0.23	—
$R_{\theta CS}$	Case-to-Sink, Flat, Greased Surface	0.24	—	°C/W
$R_{\theta JA}$	Junction-to-Ambient ⑩	—	40	—

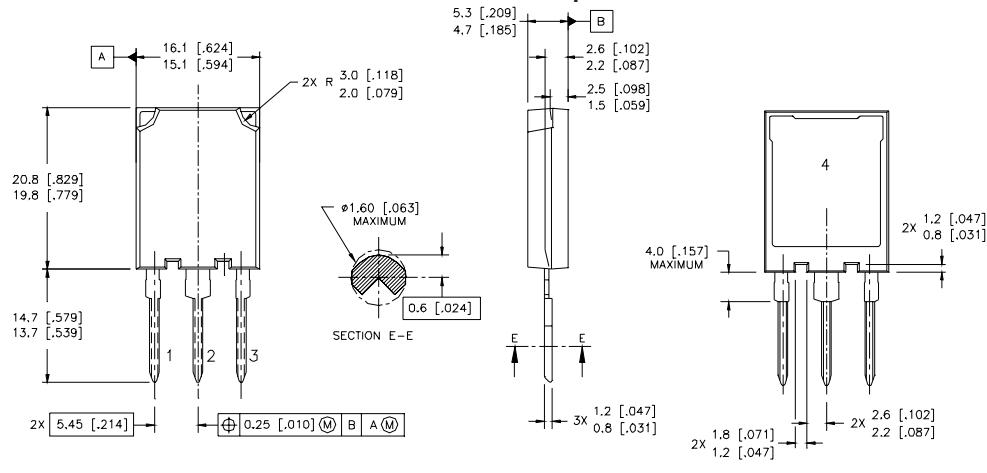
### Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See Fig. 11).
- ② Starting  $T_J = 25^\circ\text{C}$ ,  $L = 0.86\text{mH}$ ,  $R_G = 25\Omega$ ,  $I_{AS} = 46\text{A}$ . (See Figure 12).
- ③  $I_{SD} \leq 46\text{A}$ ,  $dI/dt \leq 550\text{A}/\mu\text{s}$ ,  $V_{DD} \leq V_{(\text{BR})\text{DSS}}$ ,  $T_J \leq 150^\circ\text{C}$ .
- ④ Pulse width  $\leq 400\mu\text{s}$ ; duty cycle  $\leq 2\%$ .
- ⑤  $C_{oss \text{ eff.}}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .
- ⑥  $C_{oss \text{ eff. (ER)}}$  is a fixed capacitance that stores the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .
- ⑦  $R_\theta$  is measured at  $T_J$  approximately  $90^\circ\text{C}$

## **IRFPS40N50LPbF**

### Case Outline and Dimensions — Super-247

International  
**IR** Rectifier



## NOTES:

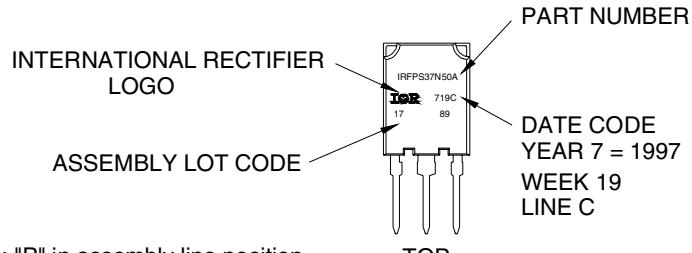
1. DIMENSIONS & TOLERANCING PER ASME Y14.5M-1994
  2. CONTROLLING DIMENSION: MILLIMETER
  3. DIMENSIONS ARE SHOWN IN MILLIMETRES [INCHES]

## LEAD ASSIGNMENTS

<u>MOSFET</u>	<u>IGBT</u>
1 - GATE	1 - GATE
2 - DRAIN	2 - COLLECTOR
3 - SOURCE	3 - Emitter
4 - DRAIN	4 - COLLECTOR

## Super-247 (TO-274AA) Part Marking Information

EXAMPLE: THIS IS AN IRFPS37N50A WITH  
ASSEMBLY LOT CODE 1789  
ASSEMBLED ON WW 19, 1997  
IN THE ASSEMBLY LINE "C"



Note: "P" in assembly line position indicates "Lead-Free"

This product has been designed and qualified for the industrial market.  
Qualification Standards can be found on IR's Web site.

International  
**IGR** Rectifier